## DATA SHEET

## 74HC4052; 74HCT4052 Dual 4-channel analog multiplexer, demultiplexer

Product specification

## Dual 4-channel analog multiplexer, demultiplexer

## FEATURES

- Wide analog input voltage range from -5 V to +5 V
- Low ON-resistance:
- $80 \Omega$ (typical) at $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EE}}=4.5 \mathrm{~V}$
- $70 \Omega$ (typical) at $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EE}}=6.0 \mathrm{~V}$
- $60 \Omega$ (typical) at $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EE}}=9.0 \mathrm{~V}$
- Logic level translation: to enable 5 V logic to communicate with $\pm 5 \mathrm{~V}$ analog signals
- Typical "break before make" built in
- Complies with JEDEC standard no. 8-1 A
- ESD protection:
- HBM EIA/JESD22-A114-A exceeds 2000 V
- MM EIA/JESD22-A115-A exceeds 200 V.
- Specified from -40 to $+85^{\circ} \mathrm{C}$ and -40 to $+125^{\circ} \mathrm{C}$.


## APPLICATIONS

- Analog multiplexing and demultiplexing
- Digital multiplexing and demultiplexing
- Signal gating.


## DESCRIPTION

The 74HC4052/74HCT4052 are high-speed Si-gate CMOS devices and are pin compatible with the HEF4052B. They are specified in compliance with JEDEC standard no. 7A.

The $74 \mathrm{HC} 4052 / 74 \mathrm{HCT} 4052$ are dual 4 -channel analog multiplexers or demultiplexers with common select logic. Each multiplexer has four independent inputs/outputs (pins nY0 to nY 3 ) and a common input/output (pin nZ). The common channel select logics include two digital select inputs (pins S 0 and S 1 ) and an active LOW enable input (pin $\bar{E}$ ). When pin $\bar{E}=$ LOW, one of the four switches is selected (low-impedance ON-state) with pins S0 and S1. When pin $\bar{E}=$ HIGH, all switches are in the high-impedance OFF-state, independent of pins SO and S1.
$\mathrm{V}_{\mathrm{CC}}$ and GND are the supply voltage pins for the digital control inputs (pins S0, S1, and E). The $\mathrm{V}_{\mathrm{Cc}}$ to GND ranges are 2.0 to 10.0 V for 74 HC 4052 and 4.5 to 5.5 V for 74 HCT 4052 . The analog inputs/outputs (pins nY0 to $n \mathrm{Y} 3$ and nZ ) can swing between $\mathrm{V}_{\mathrm{CC}}$ as a positive limit and $\mathrm{V}_{\mathrm{EE}}$ as a negative limit. $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EE}}$ may not exceed 10.0 V .

For operation as a digital multiplexer/demultiplexer, $\mathrm{V}_{\mathrm{EE}}$ is connected to GND (typically ground).

## FUNCTION TABLE

| INPUT $^{(1)}$ |  |  | CHANNEL BETWEEN |
| :---: | :---: | :---: | :--- |
| $\overline{\text { E }}$ | S1 | S0 |  |
| L | L | L |  |
| L | L | H | nY1 and nZ |
| L | H | L | nY2 and nZ |
| L | H | H | nY3 and nZ |
| H | X | X | none |

## Note

1. $\mathrm{H}=\mathrm{HIGH}$ voltage level

L = LOW voltage level
X = don't care.

Dual 4-channel analog multiplexer, demultiplexer

## QUICK REFERENCE DATA

$\mathrm{V}_{\mathrm{EE}}=\mathrm{GND}=0 \mathrm{~V} ; \mathrm{T}_{\mathrm{amb}}=25^{\circ} \mathrm{C} ; \mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=6 \mathrm{~ns}$.

| SYMBOL | PARAMETER | CONDITIONS | TYPICAL |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | 74HC4052 | 74HCT4052 |  |
| $\mathrm{t}_{\text {PZH }} / \mathrm{t}_{\text {PZL }}$ | turn-on time $\overline{\mathrm{E}}$ or Sn to $\mathrm{V}_{\text {os }}$ | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF} ; \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega ; \\ & \mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V} \end{aligned}$ | 28 | 18 | ns |
| $\mathrm{t}_{\text {PHZ }} / \mathrm{t}_{\text {PLZ }}$ | turn-off time $\overline{\mathrm{E}}$ or Sn to $\mathrm{V}_{\text {os }}$ | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF} ; \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega ; \\ & \mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V} \end{aligned}$ | 21 | 13 | ns |
| $\mathrm{C}_{1}$ | input capacitance |  | 3.5 | 3.5 | pF |
| $\mathrm{C}_{\text {PD }}$ | power dissipation capacitance per switch | notes 1 and 2 | 57 | 57 | pF |
| $\mathrm{C}_{S}$ | maximum switch capacitance | independent (Y) | 5 | 5 | pF |
|  |  | common (Z) | 12 | 12 | pF |

## Notes

1. $C_{P D}$ is used to determine the dynamic power dissipation ( $P_{D}$ in $\left.\mu \mathrm{W}\right)$.
$P_{D}=C_{P D} \times V_{C C}{ }^{2} \times f_{i} \times N+\Sigma\left[\left(C_{L}+C_{S}\right) \times V_{C C}{ }^{2} \times f_{o}\right]$ where:
$\mathrm{f}_{\mathrm{i}}=$ input frequency in MHz ;
$\mathrm{f}_{\mathrm{o}}=$ output frequency in MHz ;
$\mathrm{C}_{\mathrm{L}}=$ output load capacitance in pF ;
$\mathrm{C}_{\mathrm{S}}=$ maximum switch capacitance in pF ;
$\mathrm{V}_{\mathrm{CC}}=$ supply voltage in Volts;
$\mathrm{N}=$ total load switching outputs;
$\Sigma\left[\left(\mathrm{C}_{\mathrm{L}}+\mathrm{C}_{\mathrm{S}}\right) \times \mathrm{V}_{\mathrm{CC}}{ }^{2} \times \mathrm{f}_{\mathrm{o}}\right]=$ sum of the outputs.
2. For 74 HC 4052 the condition is $\mathrm{V}_{\mathrm{I}}=\mathrm{GND}$ to $\mathrm{V}_{\mathrm{CC}}$

For 74 HCT 4052 the condition is $\mathrm{V}_{\mathrm{I}}=\mathrm{GND}$ to $\mathrm{V}_{\mathrm{CC}}-1.5 \mathrm{~V}$.

ORDERING INFORMATION

| TYPE NUMBER | PACKAGE |  |  |  |  |
| :--- | :---: | :---: | :---: | :---: | :---: |
|  | TEMPERATURE <br> RANGE | PINS | PACKAGE | MATERIAL | CODE |
|  | -40 to $+125^{\circ} \mathrm{C}$ | 16 | SO16 | plastic | SOT109-3 |
| 74 HCT 4052 D | -40 to $+125^{\circ} \mathrm{C}$ | 16 | SO16 | plastic | SOT109-3 |
| 74 HC 4052 DB | -40 to $+125^{\circ} \mathrm{C}$ | 16 | SSOP16 | plastic | SOT338-1 |
| 74 HCT 4052 DB | -40 to $+125^{\circ} \mathrm{C}$ | 16 | SSOP16 | plastic | SOT338-1 |
| 74 HC 4052 N | -40 to $+125^{\circ} \mathrm{C}$ | 16 | DIP16 | plastic | SOT38-9 |
| 74 HCT 4052 N | -40 to $+125^{\circ} \mathrm{C}$ | 16 | DIP16 | plastic | SOT38-9 |
| 74 HC 4052 PW | -40 to $+125^{\circ} \mathrm{C}$ | 16 | TSSOP16 | plastic | SOT403-1 |
| 74 HC 4052 BQ | -40 to $+125^{\circ} \mathrm{C}$ | 16 | DHVQFN16 | plastic | SOT763-1 |
| 74 HCT 4052 BQ | -40 to $+125^{\circ} \mathrm{C}$ | 16 | DHVQFN16 | plastic | SOT763-1 |

Dual 4-channel analog multiplexer, demultiplexer

PINNING

| PIN | SYMBOL |  |
| :---: | :--- | :--- |
| 1 | 2 YO | DESCRIPTION |
| 2 | 2 Y 2 | independent input or output |
| 3 | 2 Z | independent input or output |
| 4 | 2 Y 3 | independent input or output |
| 5 | 2 Y 1 | independent input or output |
| 6 | $\overline{\mathrm{E}}$ | enable input (active LOW) |
| 7 | $\mathrm{~V}_{\mathrm{EE}}$ | negative supply voltage |
| 8 | GND | ground (0 V) |
| 9 | S 1 | select logic input |
| 10 | SO | select logic input |
| 11 | 1 Y 3 | independent input or output |
| 12 | 1 Y 0 | independent input or output |
| 13 | 1 Z | common input or output |
| 14 | 1 Y 1 | independent input or output |
| 15 | 1 Y 2 | independent input or output |
| 16 | $\mathrm{~V}_{\mathrm{CC}}$ | positive supply voltage |



Fig. 1 Pin configuration DIP16, SO16 and (T)SSOP16.


## Dual 4-channel analog multiplexer demultiplexer



Fig. 3 Logic symbol.


Fig. 4 IEC logic symbol.


Fig. 5 Functional diagram.

Dual 4-channel analog multiplexer, demultiplexer


Fig. 6 Schematic diagram (one switch).

## LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134); voltages are referenced to $\mathrm{V}_{\mathrm{EE}}=\mathrm{GND}$ (ground $=0 \mathrm{~V}$ ); note 1 .

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
| :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathrm{V}_{\mathrm{CC}}$ | supply voltage |  | -0.5 | +11.0 | V |
| $\mathrm{I}_{\mathrm{IK}}$ | input diode current | $\mathrm{V}_{\mathrm{I}}<-0.5 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{I}}>\mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V}$ | - | $\pm 20$ | mA |
| $\mathrm{I}_{\mathrm{SK}}$ | switch diode current | $\mathrm{V}_{\mathrm{S}}<-0.5 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{S}}>\mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V}$ | - | $\pm 20$ | mA |
| $\mathrm{I}_{\mathrm{S}}$ | switch current | $-0.5 \mathrm{~V}<\mathrm{V}_{\mathrm{S}}<\mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V}$ | - | $\pm 25$ | mA |
| $\mathrm{I}_{\mathrm{EE}}$ | $\mathrm{V}_{\mathrm{EE}}$ current |  | - | $\pm 20$ | mA |
| $\mathrm{I}_{\mathrm{CC}} ; \mathrm{I}_{\mathrm{GND}}$ | $\mathrm{V}_{\mathrm{CC}}$ or GND current |  | - | $\pm 50$ | mA |
| $\mathrm{~T}_{\text {Stg }}$ | storage temperature |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{P}_{\text {tot }}$ | power dissipation | $\mathrm{T}_{\mathrm{amb}}=-40$ to $+125^{\circ} \mathrm{C} ;$ note | - | 500 | mW |
| $\mathrm{P}_{\mathrm{S}}$ | power dissipation per switch |  | - | 100 | mW |

## Notes

1. To avoid drawing $\mathrm{V}_{\mathrm{CC}}$ current out of pins nZ , when switch current flows in pins nYn , the voltage drop across the bidirectional switch must not exceed 0.4 V . If the switch current flows into pins nZ , no $\mathrm{V}_{\mathrm{CC}}$ current will flow out of pins $n Y n$. In this case there is no limit for the voltage drop across the switch, but the voltages at pins $n Y n$ and $n Z$ may not exceed $\mathrm{V}_{\mathrm{CC}}$ or $\mathrm{V}_{\mathrm{EE}}$.
2. For DIP16 packages: above $70^{\circ} \mathrm{C}$ derate linearly with $12 \mathrm{~mW} / \mathrm{K}$.

For SO16 packages: above $70^{\circ} \mathrm{C}$ derate linearly with $8 \mathrm{~mW} / \mathrm{K}$.
For SSOP16 and TSSOP16 packages: above $60^{\circ} \mathrm{C}$ derate linearly with $5.5 \mathrm{~mW} / \mathrm{K}$.
For DHVQFN16 packages: above $60^{\circ} \mathrm{C}$ derate linearly with $4.5 \mathrm{~mW} / \mathrm{K}$.

Dual 4-channel analog multiplexer, demultiplexer

## RECOMMENDED OPERATING CONDITIONS

| SYMBOL | PARAMETER | CONDITIONS | 74HC4052 |  |  | 74HCT4052 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |  |
| $\mathrm{V}_{\text {CC }}$ | supply voltage | $\begin{gathered} \hline \text { see Figs } 7 \text { and } 8 \\ V_{\mathrm{CC}}-\mathrm{GND} \\ \mathrm{~V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EE}} \\ \hline \end{gathered}$ | $\begin{aligned} & 2.0 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & 5.0 \\ & 5.0 \end{aligned}$ | $\begin{aligned} & 10.0 \\ & 10.0 \end{aligned}$ | $\begin{aligned} & 4.5 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & 5.0 \\ & 5.0 \end{aligned}$ | $\begin{aligned} & 5.5 \\ & 10.0 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |
| $V_{1}$ | input voltage |  | GND | - | $\mathrm{V}_{\mathrm{CC}}$ | GND | - | $\mathrm{V}_{\mathrm{CC}}$ | V |
| $\mathrm{V}_{\mathrm{S}}$ | switch voltage |  | $\mathrm{V}_{\mathrm{EE}}$ | - | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{EE}}$ | - | $\mathrm{V}_{\mathrm{CC}}$ | V |
| $\mathrm{T}_{\text {amb }}$ | operating ambient temperature | see DC and AC characteristics per device | -40 | +25 | +85 | -40 | +25 | +85 | ${ }^{\circ} \mathrm{C}$ |
|  |  |  | -40 | - | +125 | -40 | - | +125 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{tr}_{\mathrm{r}}, \mathrm{t}_{\mathrm{f}}$ | input rise and fall times | $\mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ | - | 6.0 | 1000 | - | 6.0 | 500 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | - | 6.0 | 500 | - | 6.0 | 500 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | - | 6.0 | 400 | - | 6.0 | 500 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=10.0 \mathrm{~V}$ | - | 6.0 | 250 | - | 6.0 | 500 | ns |



Fig. 7 Guaranteed operating area as a function of the supply voltages for 74 HC 4052 .


Dual 4-channel analog multiplexer, demultiplexer

## DC CHARACTERISTICS

## Family 74HC4052

$V_{\text {is }}$ is the input voltage at pins $n Y n$ or $n Z$, whichever is assigned as an input; $V_{o s}$ is the output voltage at pins $n Z$ or $n Y n$, whichever is assigned as an output; voltages are referenced to GND (ground $=0 \mathrm{~V}$ ).

| SYMBOL | PARAMETER | TEST CONDITIONS |  |  | MIN. | TYP. | MAX. | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | OTHER | $\mathrm{V}_{\mathrm{Cc}}(\mathrm{V})$ | $\mathrm{V}_{\mathrm{EE}}(\mathrm{V})$ |  |  |  |  |
| $\mathrm{T}_{\text {amb }}=-40$ to $+85^{\circ} \mathrm{C}$; note 1 |  |  |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ | HIGH-level input voltage |  | 2.0 | - | 1.5 | 1.2 | - | V |
|  |  |  | 4.5 | - | 3.15 | 2.4 | - | V |
|  |  |  | 6.0 | - | 4.2 | 3.2 | - | V |
|  |  |  | 9.0 | - | 6.3 | 4.7 | - | V |
| $\mathrm{V}_{\mathrm{IL}}$ | LOW-level input voltage |  | 2.0 | - | - | 0.8 | 0.5 | V |
|  |  |  | 4.5 | - | - | 2.1 | 1.35 | V |
|  |  |  | 6.0 | - | - | 2.8 | 1.8 | V |
|  |  |  | 9.0 | - | - | 4.3 | 2.7 | V |
| $\mathrm{I}_{\mathrm{LI}}$ | input leakage current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}$ or GND | 6.0 | 0 | - | - | $\pm 1.0$ | $\mu \mathrm{A}$ |
|  |  |  | 10.0 | 0 | - | - | $\pm 2.0$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {S(OFF) }}$ | analog switch OFF-state current | $\begin{aligned} & \begin{array}{l} \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}} ; \\ \mathrm{V}_{\mathrm{S}} \mid=\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EE}} \text {; see Fig. } 9 \\ \text { per channel } \\ \text { all channels } \end{array} \end{aligned}$ | $\begin{array}{\|l\|} 10.0 \\ 10.0 \\ \hline \end{array}$ | $\begin{array}{\|l} 0 \\ 0 \\ \hline \end{array}$ | - | \|- | $\begin{array}{\|}  \pm 1.0 \\ \pm 2.0 \\ \hline \end{array}$ | $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {(ON })}$ | analog switch ON-state current | $\begin{aligned} & \left\lvert\, \begin{array}{l} V_{I}=V_{I H} \text { or } V_{I L} ; \\ \left\|V_{S}\right\|=V_{C C}-V_{E E} ; \text { see Fig. } 10 \end{array}\right. \end{aligned}$ | 10.0 | 0 | - | - | $\pm 2.0$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{CC}}$ | quiescent supply current | $\begin{aligned} & \mathrm{V}_{1}=\mathrm{V}_{\mathrm{CC}} \text { or } \mathrm{GND} ; \\ & \mathrm{V}_{\text {is }}=\mathrm{V}_{\mathrm{EE}} \text { or } \mathrm{V}_{\mathrm{CC}} ; \\ & \mathrm{V}_{\mathrm{oS}}=\mathrm{V}_{\mathrm{CC}} \text { or } \mathrm{V}_{\mathrm{EE}} \\ & \hline \end{aligned}$ | 6.0 | 0 | - | - | 80.0 | $\mu \mathrm{A}$ |
|  |  |  | 10.0 | 0 | - | - | 160.0 | $\mu \mathrm{A}$ |

Dual 4-channel analog multiplexer, demultiplexer

| SYMBOL | PARAMETER | TEST CONDITIONS |  |  | MIN. | TYP. | MAX. | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | OTHER | $\mathrm{V}_{\mathrm{cc}}$ (V) | $\mathrm{V}_{\mathrm{EE}}(\mathrm{V})$ |  |  |  |  |
| $\mathrm{T}_{\text {amb }}=-40$ to $+125{ }^{\circ} \mathrm{C}$ |  |  |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ | HIGH-level input voltage |  | 2.0 | - | 1.5 | - | - | V |
|  |  |  | 4.5 | - | 3.15 | - | - | V |
|  |  |  | 6.0 | - | 4.2 | - | - | V |
|  |  |  | 9.0 | - | 6.3 | - | - | V |
| $\mathrm{V}_{\text {IL }}$ | LOW-level input voltage |  | 2.0 | - | - | - | 0.5 | V |
|  |  |  | 4.5 | - | - | - | 1.35 | V |
|  |  |  | 6.0 | - | - | - | 1.8 | V |
|  |  |  | 9.0 | - | - | - | 2.7 | V |
| $\mathrm{I}_{\mathrm{LI}}$ | input leakage current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}$ or GND | 6.0 | 0 | - | - | $\pm 1.0$ | $\mu \mathrm{A}$ |
|  |  |  | 10.0 | 0 | - | - | $\pm 2.0$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {S(OFF) }}$ | analog switch OFF-state current |  | $\begin{aligned} & 10.0 \\ & 10.0 \\ & \hline \end{aligned}$ | $\begin{array}{\|l} 0 \\ 0 \\ \hline \end{array}$ | $\mid-$ | - | $\begin{aligned} & \pm 1.0 \\ & \pm 2.0 \end{aligned}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mu \mathrm{~A} \\ & \hline \end{aligned}$ |
| $\mathrm{I}_{\mathrm{S}(\mathrm{ON})}$ | analog switch ON-state current | $\begin{aligned} & V_{I}=V_{I H} \text { or } V_{I L} ; \\ & V_{S} \mid=V_{C C}-V_{E E} \text {; see Fig. } 10 \end{aligned}$ | 10.0 | 0 | - | - | $\pm 2.0$ | $\mu \mathrm{A}$ |
| ICC | quiescent supply current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}$ or GND; | 6.0 | 0 | - | - | 160 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {is }}=\mathrm{V}_{\mathrm{EE}}$ or $\mathrm{V}_{\mathrm{CC}} ;$ $\mathrm{V}_{\mathrm{OS}}=\mathrm{V}_{\mathrm{CC}}$ or $\mathrm{V}_{\mathrm{EE}}$ <br> $\mathrm{V}_{\text {os }}=\mathrm{V}_{\mathrm{CC}}$ or $\mathrm{V}_{\mathrm{EE}}$ | 10.0 | 0 | - | - | 320.0 | $\mu \mathrm{A}$ |

## Note

1. All typical values are measured at $\mathrm{T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}$.

Dual 4-channel analog multiplexer, demultiplexer

## Family 74HCT4052

$V_{\text {is }}$ is the input voltage at pins $n Y n$ or $n Z$, whichever is assigned as an input; $V_{o s}$ is the output voltage at pins $n Z$ or $n Y n$, whichever is assigned as an output; voltages are referenced to GND (ground $=0 \mathrm{~V}$ ).

| SYMBOL | PARAMETER | TEST CONDITIONS |  |  | MIN. | TYP. | MAX. | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | OTHER | $\mathrm{V}_{\mathrm{cc}}(\mathrm{V})$ | $\mathrm{V}_{\mathrm{EE}}(\mathrm{V})$ |  |  |  |  |
| $\mathrm{T}_{\text {amb }}=-40$ to $+85^{\circ} \mathrm{C}$; note 1 |  |  |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ | HIGH-level input voltage |  | 4.5 to 5.5 | - | 2.0 | 1.6 | - | V |
| VIL | LOW-level input voltage |  | 4.5 to 5.5 | - | - | 1.2 | 0.8 | V |
| $\mathrm{I}_{\text {LI }}$ | input leakage current | $\mathrm{V}_{1}=\mathrm{V}_{\text {CC }}$ or GND | 5.5 | 0 | - | - | $\pm 1.0$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {S(OFF) }}$ | analog switch OFF-state current |  | $\begin{aligned} & 10.0 \\ & 10.0 \end{aligned}$ | $\begin{aligned} & 0 \\ & 0 \end{aligned}$ | - | - | $\begin{aligned} & \pm 1.0 \\ & \pm 2.0 \end{aligned}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mu \mathrm{~A} \end{aligned}$ |
| $\mathrm{I}_{\mathrm{S}(\mathrm{ON})}$ | analog switch ON-state current | $\begin{aligned} & \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}} ; \\ & \mathrm{V}_{\mathrm{S}}=\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EE}} \text {; see Fig. } 10 \end{aligned}$ | 10.0 | 0 | - | - | $\pm 2.0$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{Cc}}$ | quiescent supply | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}} \text { or } \mathrm{GND} ;$ | 5.5 | 0 | - | - | 80.0 | $\mu \mathrm{A}$ |
|  | current | $\mathrm{V}_{\text {is }}=\mathrm{V}_{\mathrm{EE}}$ or $\mathrm{V}_{\mathrm{CC}}$; <br> $\mathrm{V}_{\mathrm{OS}}=\mathrm{V}_{\mathrm{CC}}$ or $\mathrm{V}_{\mathrm{EE}}$ | 5.0 | -5.0 | - | - | 160.0 | $\mu \mathrm{A}$ |
| $\Delta \mathrm{l}_{\mathrm{CC}}$ | additional quiescent supply current per input | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}-2.1 \mathrm{~V}$; other inputs at $\mathrm{V}_{\mathrm{CC}}$ or GND | 4.5 to 5.5 | 0 | - | 45 | 202.5 | $\mu \mathrm{A}$ |
| $\mathrm{T}_{\mathrm{amb}}=-40$ to $+125{ }^{\circ} \mathrm{C}$ |  |  |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ | HIGH-level input voltage |  | 4.5 to 5.5 | - | 2.0 | - | - | V |
| VIL | LOW-level input voltage |  | 4.5 to 5.5 | - | - | - | 0.8 | V |
| $\mathrm{I}_{\mathrm{LI}}$ | input leakage current | $\mathrm{V}_{1}=\mathrm{V}_{\text {CC }}$ or GND | 5.5 | 0 | - | - | $\pm 1.0$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {S(OFF) }}$ | analog switch OFF-state current | $\begin{aligned} & \mathrm{V}_{I}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}} ; \\ & \mathrm{V}_{\mathrm{S}} \mid=\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EE}} ; \text { see Fig. } 9 \\ & \text { per channel } \\ & \text { all channels } \end{aligned}$ | $\begin{aligned} & 10.0 \\ & 10.0 \end{aligned}$ | $\begin{array}{\|l} 0 \\ 0 \\ \hline \end{array}$ | - | - | $\begin{array}{r}  \pm 1.0 \\ \pm 2.0 \\ \hline \end{array}$ | $\begin{array}{r} \mu \mathrm{A} \\ \mu \mathrm{~A} \\ \hline \end{array}$ |
| $\mathrm{I}_{\mathrm{S}(\mathrm{ON})}$ | analog switch ON-state current | $\begin{aligned} & V_{I}=V_{I H} \text { or } V_{I L} ; \\ & V_{S} \mid=V_{C C}-V_{E E} \text {; see Fig. } 10 \end{aligned}$ | 10.0 | 0 | - | - | $\pm 2.0$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{CC}}$ | quiescent supply current | $\begin{aligned} & \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}} \text { or } \mathrm{GND} ; \\ & \mathrm{V}_{\text {is }}=\mathrm{V}_{\mathrm{EE}} \text { or } \mathrm{V}_{\mathrm{CC}} ; \\ & \mathrm{V}_{\mathrm{OS}}=\mathrm{V}_{\mathrm{CC}} \text { or } \mathrm{V}_{\mathrm{EE}} \\ & \hline \end{aligned}$ | 5.5 | 0 | - | - | 160.0 | $\mu \mathrm{A}$ |
|  |  |  | 5.0 | -5.0 | - | - | 320.0 | $\mu \mathrm{A}$ |
| $\Delta \mathrm{I}_{\text {CC }}$ | additional quiescent supply current per input | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}-2.1 \mathrm{~V}$; other inputs at $\mathrm{V}_{\mathrm{CC}}$ or GND | 4.5 to 5.5 | 0 | - | - | 220.5 | $\mu \mathrm{A}$ |

## Note

1. All typical values are measured at $\mathrm{T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}$.

## Dual 4-channel analog multiplexer, demultiplexer



Fig. 9 Test circuit for measuring OFF-state current.


Fig. 10 Test circuit for measuring ON-state current.

Dual 4-channel analog multiplexer, demultiplexer

## Resistance Row for 74HC4052 and 74HCT4052

$V_{\text {is }}$ is the input voltage at pins $n Y n$ or $n Z$, whichever is assigned as an input; see notes 1 and 2; see Fig.11.

| SYMBOL | PARAMETER | TEST CONDITIONS |  |  |  | MIN. | TYP. | MAX. | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | OTHER | $\mathrm{V}_{\text {cc }}$ (V) | $\mathrm{V}_{\mathrm{EE}}(\mathrm{V})$ | $\mathrm{I}_{\mathrm{S}}(\mu \mathrm{A})$ |  |  |  |  |
| $\mathrm{T}_{\text {amb }}=-40$ to $+85^{\circ} \mathrm{C}$; note 3 |  |  |  |  |  |  |  |  |  |
| $\mathrm{R}_{\text {ON( } \text { (eak) }}$ | ON-resistance (peak) | $\begin{aligned} & V_{\text {is }}=V_{C C} \text { to } V_{\text {EE }} ; \\ & V_{I}=V_{I H} \text { or } V_{I L} \end{aligned}$ | 2.0 | 0 | 100 | - | - | - | $\Omega$ |
|  |  |  | 4.5 | 0 | 1000 | - | 100 | 225 | $\Omega$ |
|  |  |  | 6.0 | 0 | 1000 | - | 90 | 200 | $\Omega$ |
|  |  |  | 4.5 | -4.5 | 1000 | - | 70 | 165 | $\Omega$ |
| $\mathrm{R}_{\mathrm{ON} \text { (rail) }}$ | ON-resistance (rail) | $\begin{aligned} & \mathrm{V}_{\text {is }}=\mathrm{V}_{\mathrm{EE}} ; \\ & \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}} \end{aligned}$ | 2.0 | 0 | 100 | - | 150 | - | $\Omega$ |
|  |  |  | 4.5 | 0 | 1000 | - | 80 | 175 | $\Omega$ |
|  |  |  | 6.0 | 0 | 1000 | - | 70 | 150 | $\Omega$ |
|  |  |  | 4.5 | -4.5 | 1000 | - | 60 | 130 | $\Omega$ |
|  |  | $\begin{aligned} & \mathrm{V}_{\text {is }}=\mathrm{V}_{\mathrm{CC}} ; \\ & \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}} \end{aligned}$ | 2.0 | 0 | 100 | - | 150 | - | $\Omega$ |
|  |  |  | 4.5 | 0 | 1000 | - | 90 | 200 | $\Omega$ |
|  |  |  | 6.0 | 0 | 1000 | - | 80 | 175 | $\Omega$ |
|  |  |  | 4.5 | -4.5 | 1000 | - | 65 | 150 | $\Omega$ |
| $\Delta \mathrm{R}_{\text {ON }}$ | maximum ON-resistance difference between any two channels | $\begin{aligned} & V_{\text {is }}=V_{C C} \text { to } V_{\text {EE }} ; \\ & V_{I}=V_{I H} \text { or } V_{I L} \end{aligned}$ | 2.0 | 0 | - | - | - | - | $\Omega$ |
|  |  |  | 4.5 | 0 | - | - | 9 | - | $\Omega$ |
|  |  |  | 6.0 | 0 | - | - | 8 | - | $\Omega$ |
|  |  |  | 4.5 | -4.5 | - | - | 6 | - | $\Omega$ |
| $\mathrm{T}_{\text {amb }}=-40$ to $+125{ }^{\circ} \mathrm{C}$ |  |  |  |  |  |  |  |  |  |
| $\mathrm{R}_{\text {ON( } \text { (peak) }}$ | ON-resistance (peak) | $\begin{aligned} & \mathrm{V}_{\text {is }}=\mathrm{V}_{\mathrm{CC}} \text { to } \mathrm{V}_{\mathrm{EE}} ; \\ & \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}} \end{aligned}$ | 2.0 | 0 | 100 | - | - | - | $\Omega$ |
|  |  |  | 4.5 | 0 | 1000 | - | - | 270 | $\Omega$ |
|  |  |  | 6.0 | 0 | 1000 | - | - | 240 | $\Omega$ |
|  |  |  | 4.5 | -4.5 | 1000 | - | - | 195 | $\Omega$ |
| R ${ }_{\text {ON(rail }}$ | ON-resistance (rail) | $\begin{aligned} & \mathrm{V}_{\text {is }}=\mathrm{V}_{\mathrm{EE}} ; \\ & \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}} \end{aligned}$ | 2.0 | 0 | 100 | - | - | - | $\Omega$ |
|  |  |  | 4.5 | 0 | 1000 | - | - | 210 | $\Omega$ |
|  |  |  | 6.0 | 0 | 1000 | - | - | 180 | $\Omega$ |
|  |  |  | 4.5 | -4.5 | 1000 | - | - | 160 | $\Omega$ |
|  |  | $\begin{aligned} & \mathrm{V}_{\text {is }}=\mathrm{V}_{\mathrm{CC}} ; \\ & \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}} \end{aligned}$ | 2.0 | 0 | 100 | - | - | - | $\Omega$ |
|  |  |  | 4.5 | 0 | 1000 | - | - | 240 | $\Omega$ |
|  |  |  | 6.0 | 0 | 1000 | - | - | 210 | $\Omega$ |
|  |  |  | 4.5 | -4.5 | 1000 | - | - | 180 | $\Omega$ |

## Notes

1. For 74 HC 4052 : $\mathrm{V}_{\mathrm{CC}}-\mathrm{GND}$ or $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EE}}=2.0,4.5,6.0$ and 9.0 V ; for $74 \mathrm{HCT} 4052: \mathrm{V}_{\mathrm{CC}}-\mathrm{GND}=4.5$ and 5.5 V , $V_{C C}-V_{E E}=2.0,4.5,6.0$ and 9.0 V .
2. When supply voltages $\left(\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EE}}\right)$ near 2.0 V the analog switch ON -resistance becomes extremely non-linear. When using a supply of 2 V , it is recommended to use these devices only for transmitting digital signals.
3. All typical values are measured at $\mathrm{T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}$.

## Dual 4-channel analog multiplexer, demultiplexer



Fig. 11 Test circuit for measuring $\mathrm{R}_{\mathrm{ON}}$.

$\mathrm{V}_{\text {is }}=0$ to $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EE}}$
(1) $V_{C C}=4.5 \mathrm{~V}$
(2) $V_{C C}=6 \mathrm{~V}$
(3) $\mathrm{V}_{\mathrm{CC}}=9 \mathrm{~V}$

Fig. 12 Typical RON as a function of input voltage $\mathrm{V}_{\text {is }}$.

Dual 4-channel analog multiplexer, demultiplexer

## AC CHARACTERISTICS

## Type 74HC4052

$\mathrm{GND}=0 \mathrm{~V} ; \mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=6 \mathrm{~ns} ; \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$.

| SYMBOL | PARAMETER | TEST CONDITIONS |  |  | MIN. | TYP. | MAX. | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | OTHER | $\mathrm{V}_{\mathrm{Cc}}(\mathrm{V})$ | $\mathrm{V}_{\mathrm{EE}}(\mathrm{V})$ |  |  |  |  |
| $\mathrm{T}_{\text {amb }}=-40$ to $+85^{\circ} \mathrm{C}$; note 1 |  |  |  |  |  |  |  |  |
| $\mathrm{t}_{\text {PHL }} / \mathrm{t}_{\text {PLH }}$ | propagation delay $\mathrm{V}_{\text {is }}$ to $\mathrm{V}_{\text {os }}$ | $\mathrm{R}_{\mathrm{L}}=\infty$; see Fig. 19 | 2.0 | 0 | - | 14 | 75 | ns |
|  |  |  | 4.5 | 0 | - | 5 | 15 | ns |
|  |  |  | 6.0 | 0 | - | 4 | 13 | ns |
|  |  |  | 4.5 | -4.5 | - | 4 | 10 | ns |
| $\mathrm{t}_{\text {PZH }} / \mathrm{t}_{\text {PZL }}$ | turn-on time $\overline{\mathrm{E}}$, Sn to $\mathrm{V}_{\text {os }}$ | $\mathrm{R}_{\mathrm{L}}=\infty \text {; see Figs 20, }$ 22 and 21 | 2.0 | 0 | - | 105 | 405 | ns |
|  |  |  | 4.5 | 0 | - | 38 | 81 | ns |
|  |  |  | 6.0 | 0 | - | 30 | 69 | ns |
|  |  |  | 4.5 | -4.5 | - | 26 | 58 | ns |
| $\mathrm{t}_{\text {PHZ }} / \mathrm{t}_{\text {PLZ }}$ | turn-off time $\overline{\mathrm{E}}$, Sn to $\mathrm{V}_{\text {os }}$ | $R_{L}=1 \mathrm{k} \Omega \text {; see Figs 20, }$ 22 and 21 | 2.0 | 0 | - | 74 | 315 | ns |
|  |  |  | 4.5 | 0 | - | 27 | 63 | ns |
|  |  |  | 6.0 | 0 | - | 22 | 54 | ns |
|  |  |  | 4.5 | -4.5 | - | 22 | 48 | ns |
| $\mathrm{T}_{\mathrm{amb}}=-40$ to $+125{ }^{\circ} \mathrm{C}$ |  |  |  |  |  |  |  |  |
| $\mathrm{t}_{\text {PHL }} / \mathrm{t}_{\text {PLH }}$ | propagation delay $\mathrm{V}_{\text {is }}$ to $\mathrm{V}_{\text {os }}$ | $\mathrm{R}_{\mathrm{L}}=\infty$; see Fig. 19 | 2.0 | 0 | - | - | 90 | ns |
|  |  |  | 4.5 | 0 | - | - | 18 | ns |
|  |  |  | 6.0 | 0 | - | - | 15 | ns |
|  |  |  | 4.5 | -4.5 | - | - | 12 | ns |
| $\mathrm{t}_{\text {PZH }} / \mathrm{t}_{\text {PZL }}$ | turn-on time $\overline{\mathrm{E}}$, Sn to $\mathrm{V}_{\text {os }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=\infty ; \text { see Figs } 20, \\ & 22 \text { and } 21 \end{aligned}$ | 2.0 | 0 | - | - | 490 | ns |
|  |  |  | 4.5 | 0 | - | - | 98 | ns |
|  |  |  | 6.0 | 0 | - | - | 83 | ns |
|  |  |  | 4.5 | -4.5 | - | - | 69 | ns |
| $\mathrm{t}_{\text {PHZ }} / \mathrm{t}_{\text {PLZ }}$ | turn-off time $\overline{\mathrm{E}}$, Sn to $\mathrm{V}_{\text {os }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \text {; see Figs } 20, \\ & 22 \text { and } 21 \end{aligned}$ | 2.0 | 0 | - | - | 375 | ns |
|  |  |  | 4.5 | 0 | - | - | 75 | ns |
|  |  |  | 6.0 | 0 | - | - | 64 | ns |
|  |  |  | 4.5 | -4.5 | - | - | 57 | ns |

## Note

1. All typical values are measured at $\mathrm{T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}$.

## Dual 4-channel analog multiplexer,

 demultiplexerType 74HCT4052
GND $=0 \mathrm{~V} ; \mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=6 \mathrm{~ns} ; \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$.

| SYMBOL | PARAMETER | TEST CONDITIONS |  |  | MIN. | TYP. | MAX. | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | OTHER | $\mathrm{V}_{\mathrm{cc}}$ (V) | $\mathrm{V}_{\mathrm{EE}}(\mathrm{V})$ |  |  |  |  |
| $\mathrm{T}_{\text {amb }}=-40$ to $+85^{\circ} \mathrm{C}$; note 1 |  |  |  |  |  |  |  |  |
| $\mathrm{t}_{\text {PHL }} / \mathrm{t}_{\text {PLH }}$ | propagation delay $\mathrm{V}_{\text {is }}$ to $\mathrm{V}_{\text {os }}$ | $\mathrm{R}_{\mathrm{L}}=\infty$; see Fig. 19 | 4.5 | 0 | - | 5 | 15 | ns |
|  |  |  | 4.5 | -4.5 | - | 4 | 10 | ns |
| $\mathrm{t}_{\text {PZH }} / \mathrm{t}_{\text {PZL }}$ | turn-on time $\overline{\mathrm{E}}$, Sn to $\mathrm{V}_{\text {os }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \text {; see Figs } 20, \\ & 22 \text { and } 21 \end{aligned}$ | 4.5 | 0 | - | 41 | 88 | ns |
|  |  |  | 4.5 | -4.5 | - | 28 | 60 | ns |
| $\mathrm{t}_{\text {PHZ }} \mathrm{t}_{\text {PLZ }}$ | turn-off time $\overline{\mathrm{E}}$, Sn to $\mathrm{V}_{\text {os }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \text {; see Figs } 20, \\ & 22 \text { and } 21 \end{aligned}$ | 4.5 | 0 | - | 26 | 63 | ns |
|  |  |  | 4.5 | -4.5 | - | 21 | 48 | ns |
| $\mathrm{T}_{\text {amb }}=-40$ to $+125{ }^{\circ} \mathrm{C}$ |  |  |  |  |  |  |  |  |
| $\mathrm{t}_{\text {PHL }} / \mathrm{t}_{\text {PLH }}$ | propagation delay $\mathrm{V}_{\text {is }}$ to $\mathrm{V}_{\text {os }}$ | $\mathrm{R}_{\mathrm{L}}=\infty$; see Fig. 19 | 4.5 | 0 | - | - | 18 | ns |
|  |  |  | 4.5 | -4.5 | - | - | 12 | ns |
| $\mathrm{t}_{\text {PZH }} / \mathrm{t}_{\text {PZL }}$ | turn-on time $\overline{\mathrm{E}}$, Sn to $\mathrm{V}_{\text {os }}$ | $\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \text {; see Figs } 20 \text {, }$ 22 and 21 | 4.5 | 0 | - | - | 105 | ns |
|  |  |  | 4.5 | -4.5 | - | - | 72 | ns |
| $\mathrm{t}_{\text {PHZ }} / \mathrm{t}_{\text {PLZ }}$ | turn-off time $\overline{\mathrm{E}}$, Sn to $\mathrm{V}_{\text {os }}$ | $R_{L}=1 \mathrm{k} \Omega$; see Figs 20, 22 and 21 | 4.5 | 0 | - | - | 75 | ns |
|  |  |  | 4.5 | -4.5 | - | - | 57 | ns |

## Note

1. All typical values are measured at $\mathrm{T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}$.

## Dual 4-channel analog multiplexer, demultiplexer

## Type 74HC4052 and 74HCT4052

Recommended conditions and typical values; $\mathrm{GND}=0 \mathrm{~V} ; \mathrm{T}_{\mathrm{amb}}=25^{\circ} \mathrm{C} ; \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$. $\mathrm{V}_{\text {is }}$ is the input voltage at pins nYn or $n Z$, whichever is assigned as an input. $V_{o s}$ is the output voltage at pins $n Y n$ or $n Z$, whichever is assigned as an output.

| SYMBOL | PARAMETER | TEST CONDITIONS |  |  |  | TYP. | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | OTHER | $\begin{gathered} V_{i s(p-p)} \\ (V) \end{gathered}$ | $\mathrm{V}_{\mathrm{cc}}(\mathrm{V})$ | $\mathrm{V}_{\mathrm{EE}}(\mathrm{V})$ |  |  |
| $\mathrm{d}_{\text {sin }}$ | sine-wave distortion | $\begin{aligned} & f=1 \mathrm{kHz} ; \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega ; \\ & \text { see Fig. } 13 \end{aligned}$ | 4.0 | 2.25 | -2.25 | 0.04 | \% |
|  |  |  | 8.0 | 4.5 | -4.5 | 0.02 | \% |
|  |  | $\begin{aligned} & \mathrm{f}=10 \mathrm{kHz} ; \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega ; \\ & \text { see Fig. } 13 \end{aligned}$ | 4.0 | 2.25 | -2.25 | 0.12 | \% |
|  |  |  | 8.0 | 4.5 | -4.5 | 0.06 | \% |
| $\alpha_{\text {OFF(feedthr) }}$ | switch OFF signal feed-through | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=600 \Omega ; \mathrm{f}=1 \mathrm{MHz} ; \\ & \text { see Figs } 14 \text { and } 15 \end{aligned}$ | note 1 | 2.25 | -2.25 | -50 | dB |
|  |  |  |  | 4.5 | -4.5 | -50 | dB |
| $\alpha_{\text {ct(s) }}$ | crosstalk between two switches/multiplexers | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=600 \Omega ; \mathrm{f}=1 \mathrm{MHz} ; \\ & \text { see Fig. } 16 \end{aligned}$ | note 1 | 2.25 | -2.25 | -60 | dB |
|  |  |  |  | 4.5 | -4.5 | -60 | dB |
| $\mathrm{V}_{\mathrm{ct}(\mathrm{p}-\mathrm{p})}$ | crosstalk voltage between control and any switch (peak-to-peak value) | $R_{L}=600 \Omega ; f=1 \mathrm{MHz} ; \overline{\mathrm{E}}$ or Sn , square-wave between $\mathrm{V}_{\mathrm{CC}}$ and GND, $\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=6 \mathrm{~ns}$; see Fig. 17 | - | 4.5 | 0 | 110 | mV |
|  |  |  |  | 4.5 | -4.5 | 220 | mV |
| $\mathrm{f}_{\text {max }}$ | minimum frequency response (-3dB) | $\mathrm{R}_{\mathrm{L}}=50 \Omega$; see Figs 13 and 18 | note 2 | 2.25 | -2.25 | 170 | MHz |
|  |  |  |  | 4.5 | -4.5 | 180 | MHz |
| $\mathrm{C}_{S}$ | maximum switch capacitance | independent (Y) | - | - | - | 5 | pF |
|  |  | common (Z) | - | - | - | 12 | pF |

## Notes

1. Adjust input voltage $\mathrm{V}_{\text {is }}$ to 0 dBm level $(0 \mathrm{dBm}=1 \mathrm{~mW}$ into $600 \Omega)$.
2. Adjust input voltage $\mathrm{V}_{\text {is }}$ to 0 dBm level at $\mathrm{V}_{\text {os }}$ for $1 \mathrm{MHz}(0 \mathrm{dBm}=1 \mathrm{~mW}$ into $50 \Omega)$.


Fig. 13 Test circuit for measuring sine-wave distortion and minimum frequency response.

Dual 4-channel analog multiplexer, demultiplexer


Fig. 14 Test circuit for measuring switch OFF signal feed-through.


Test conditions: $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V} ; \mathrm{GND}=0 \mathrm{~V} ; \mathrm{V}_{\mathrm{EE}}=-4.5 \mathrm{~V} ; \mathrm{R}_{\mathrm{L}}=50 \Omega ; \mathrm{R}_{\text {source }}=1 \mathrm{k} \Omega$.
Fig. 15 Typical switch OFF signal feed-through as a function of frequency.


Fig. 16 Test circuits for measuring crosstalk between any two switches/multiplexers.

Dual 4-channel analog multiplexer, demultiplexer


Fig. 17 Test circuit for measuring crosstalk between control and any switch.


## Dual 4-channel analog multiplexer, demultiplexer

## AC WAVEFORMS



Fig. 19 Waveforms showing the input $\left(\mathrm{V}_{\text {is }}\right)$ to output $\left(\mathrm{V}_{\mathrm{os}}\right)$ propagation delays.


For 74 HC 4052 : $\mathrm{V}_{\mathrm{M}}=50 \%$; $\mathrm{V}_{\mathrm{I}}=\mathrm{GND}$ to $\mathrm{V}_{\mathrm{CC}}$.
For 74 HCT 4052 : $\mathrm{V}_{\mathrm{M}}=1.3 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=\mathrm{GND}$ to 3 V .
Fig. 20 Waveforms showing the turn-on and turn-off times.

Dual 4-channel analog multiplexer, demultiplexer



Fig. 22 Test circuit for measuring AC performance.

## Dual 4-channel analog multiplexer, demultiplexer

## PACKAGE OUTLINES

SO16: plastic small outline package; 16 leads; body width 3.9 mm ; body thickness 1.47 mm
SOT109-3


DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | $\mathbf{A}$ |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathbf{m a x}$. | $\mathbf{A}_{\mathbf{1}}$ | $\mathbf{A}_{\mathbf{2}}$ | $\mathbf{A}_{\mathbf{3}}$ | $\mathbf{b}_{\mathbf{p}}$ | $\mathbf{c}$ | $\mathbf{D}^{(\mathbf{1})}$ | $\mathbf{E}^{(\mathbf{1})}$ | $\mathbf{e}$ | $\mathbf{H} \mathbf{E}$ | $\mathbf{L}$ | $\mathbf{L}_{\mathbf{p}}$ | $\mathbf{v}$ | $\mathbf{w}$ | $\mathbf{y}$ | $\mathbf{Z}^{(\mathbf{1})}$ | $\boldsymbol{\theta}$ |  |
| mm | 1.75 | 0.25 | 1.55 | 0.25 | 0.49 | 0.25 | 10.0 | 4.0 | 1.27 | 6.2 | 1.05 | 1.0 | 0.25 | 0.25 | 0.1 | 0.7 |  |
|  |  | 0.10 | 1.40 |  | 0.36 | 0.19 | 9.8 | 3.8 | 1.2 | 5.8 |  | 0.4 |  |  |  | 0.3 | $8^{0}$ |
| inches | 0.069 | 0.010 | 0.061 | 0.01 | 0.019 | 0.0100 | 0.39 | 0.16 | 0.05 | 0.244 | 0.041 | 0.039 | 0.01 | 0.01 | 0.004 | 0.028 |  |
|  | 0.055 | 0.014 | 0.0075 | 0.38 | 0.15 | 0.0 | 0.228 |  | 0.016 |  | 0.012 |  |  |  |  |  |  |

Note

1. Plastic or metal protrusions of $0.15 \mathrm{~mm}(0.006 \mathrm{inch})$ maximum per side are not included.

| OUTLINE <br> VERSION | REFERENCES |  |  |  | EUROPEAN <br> PROJJECTION | ISSUE DATE |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  |  |
| SOT109-3 |  | MS-012AC |  |  | $-98-12-23$ |  |
| $03-02-19$ |  |  |  |  |  |  |

## Dual 4-channel analog multiplexer, demultiplexer



DIMENSIONS (mm are the original dimensions)

| UNIT | $\mathbf{A}$ | $\mathbf{m a x}$. | $\mathbf{A}_{\mathbf{1}}$ | $\mathbf{A}_{\mathbf{2}}$ | $\mathbf{A}_{\mathbf{3}}$ | $\mathbf{b}_{\mathbf{p}}$ | $\mathbf{c}$ | $\mathbf{D}^{(\mathbf{1})}$ | $\mathbf{E}^{(\mathbf{1})}$ | $\mathbf{e}$ | $\mathbf{H}_{\mathbf{E}}$ | $\mathbf{L}$ | $\mathbf{L}_{\mathbf{p}}$ | $\mathbf{Q}$ | $\mathbf{v}$ | $\mathbf{w}$ | $\mathbf{y}$ | $\mathbf{Z}^{(\mathbf{1})}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 2 | 0.21 | 1.80 | 0.25 | 0.38 | 0.20 | 6.4 | 5.4 | 0.65 | 7.9 | 1.25 | 1.03 | 0.9 | 0.2 | 0.13 | 0.1 | 1.00 | $8^{\circ}$ |
|  |  | 0.05 | 1.65 |  | 0.25 | 0.09 | 6.0 | 5.2 | 0.6 | 7.6 |  | 0.63 | 0.7 |  |  | 0.5 | $0^{\circ}$ |  |

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES |  |  | EUROPEAN PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  |
| SOT338-1 |  | MO-150 |  | $\square$ (®) | $\begin{aligned} & \hline 9-12-27 \\ & 03-02-19 \end{aligned}$ |

## Dual 4-channel analog multiplexer, demultiplexer



DIMENSIONS ( mm dimensions are derived from the original inch dimensions)

| UNIT | $\underset{\max .}{A}$ | $\mathrm{A}_{1}$ min. | $\begin{aligned} & \mathrm{A}_{2} \\ & \max . \end{aligned}$ | b | $\mathrm{b}_{1}$ | $\mathrm{b}_{2}$ | c | $D^{(1)}$ | $E^{(1)}$ | e | $\mathrm{e}_{1}$ | L | $\mathrm{M}_{\mathrm{E}}$ | $\mathrm{M}_{\mathbf{H}}$ | w | $\begin{gathered} Z^{(1)} \\ \max . \end{gathered}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 4.32 | 0.38 | 3.56 | $\begin{aligned} & 1.65 \\ & 1.40 \end{aligned}$ | $\begin{aligned} & 0.51 \\ & 0.41 \end{aligned}$ | $\begin{aligned} & 1.14 \\ & 0.76 \end{aligned}$ | $\begin{aligned} & 0.36 \\ & 0.20 \end{aligned}$ | $\begin{aligned} & 19.3 \\ & 18.8 \end{aligned}$ | $\begin{aligned} & 6.45 \\ & 6.24 \end{aligned}$ | 2.54 | 7.62 | $\begin{aligned} & 3.81 \\ & 2.92 \end{aligned}$ | $\begin{aligned} & 8.23 \\ & 7.62 \end{aligned}$ | $\begin{aligned} & 9.40 \\ & 8.38 \end{aligned}$ | 0.254 | 0.76 |
| inches | 0.17 | 0.015 | 0.14 | $\begin{aligned} & 0.065 \\ & 0.055 \end{aligned}$ | $\begin{aligned} & 0.020 \\ & 0.016 \end{aligned}$ | $\begin{aligned} & 0.045 \\ & 0.030 \end{aligned}$ | $\begin{aligned} & 0.014 \\ & 0.008 \end{aligned}$ | $\begin{aligned} & 0.76 \\ & 0.74 \end{aligned}$ | $\begin{aligned} & 0.254 \\ & 0.246 \end{aligned}$ | 0.1 | 0.3 | $\begin{aligned} & 0.150 \\ & 0.115 \end{aligned}$ | $\begin{aligned} & 0.324 \\ & 0.300 \end{aligned}$ | $\begin{aligned} & 0.37 \\ & 0.33 \end{aligned}$ | 0.01 | 0.03 |

Note

1. Plastic or metal protrusions of 0.25 mm ( 0.01 inch ) maximum per side are not included.

| OUTLINE <br> VERSION | REFERENCES |  |  | EUROPEAN PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  |
| SOT38-9 |  |  |  | $\oplus$ | $\begin{aligned} & \hline-97-07-24 \\ & 03-03-12 \end{aligned}$ |

## Dual 4-channel analog multiplexer, demultiplexer



DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | $\mathrm{A}_{1}$ | $\mathrm{A}_{2}$ | $A_{3}$ | $\mathrm{b}_{\mathrm{p}}$ | c | $\mathrm{D}^{(1)}$ | $E^{(2)}$ | e | $\mathrm{H}_{\mathrm{E}}$ | L | $L_{p}$ | Q | v | w | y | $\mathrm{Z}^{(1)}$ | $\theta$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 1.1 | $\begin{aligned} & 0.15 \\ & 0.05 \end{aligned}$ | $\begin{aligned} & 0.95 \\ & 0.80 \end{aligned}$ | 0.25 | $\begin{aligned} & 0.30 \\ & 0.19 \end{aligned}$ | $\begin{aligned} & 0.2 \\ & 0.1 \end{aligned}$ | $\begin{aligned} & 5.1 \\ & 4.9 \end{aligned}$ | $\begin{aligned} & 4.5 \\ & 4.3 \end{aligned}$ | 0.65 | $\begin{aligned} & 6.6 \\ & 6.2 \end{aligned}$ | 1 | $\begin{aligned} & 0.75 \\ & 0.50 \end{aligned}$ | $\begin{aligned} & 0.4 \\ & 0.3 \end{aligned}$ | 0.2 | 0.13 | 0.1 | $\begin{aligned} & 0.40 \\ & 0.06 \end{aligned}$ | $8^{\circ}$ $0^{\circ}$ |

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE <br> VERSION | REFERENCES |  |  |  | EUROPEAN <br> PROJECTION | ISSUE DATE |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  |  |
| SOT403-1 |  | MO-153 |  |  | - | $-99-12-27$ |

Dual 4-channel analog multiplexer, demultiplexer

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body $2.5 \times 3.5 \times 0.85 \mathrm{~mm}$

$\xrightarrow[\text { scale }]{0}$
DIMENSIONS (mm are the original dimensions)

| UNIT | $\mathbf{A}^{(1)}$ <br> $\mathbf{m a x}$. | $\mathbf{A}_{\mathbf{1}}$ | $\mathbf{b}$ | $\mathbf{c}$ | $\mathbf{D}^{(\mathbf{1})}$ | $\mathbf{D}_{\mathbf{h}}$ | $\mathbf{E}^{(1)}$ | $\mathbf{E}_{\mathbf{h}}$ | $\mathbf{e}$ | $\mathbf{e}_{\mathbf{1}}$ | $\mathbf{L}$ | $\mathbf{v}$ | $\mathbf{w}$ | $\mathbf{y}$ | $\mathbf{y}_{\mathbf{1}}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 1 | 0.05 | 0.30 | 0.2 | 3.6 | 2.15 | 2.6 | 1.15 | 0.5 | 2.5 | 0.5 | 0.1 | 0.05 | 0.05 | 0.1 |
|  | 0.00 | 0.18 | 0.2 | 3.4 | 1.85 | 2.4 | 0.85 | 0.5 | 2.5 | 0.3 | 0.1 |  |  |  |  |

Note

1. Plastic or metal protrusions of 0.075 mm maximum per side are not included.

| OUTLINE <br> VERSION | REFERENCES |  |  |  | EUROPEAN <br> PROJECTION | ISSUE DATE |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  |  |
| SOT763-1 | $\ldots-$ | MO-241 | $\ldots$ |  | - |  |

## Dual 4-channel analog multiplexer, demultiplexer

## 74HC4052; 74HCT4052

## SOLDERING

## Introduction to soldering surface mount packages

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our "Data Handbook IC26; Integrated Circuit Packages" (document order number 9398652 90011).

There is no soldering method that is ideal for all surface mount IC packages. Wave soldering can still be used for certain surface mount ICs, but it is not suitable for fine pitch SMDs. In these situations reflow soldering is recommended.

## Reflow soldering

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement. Driven by legislation and environmental forces the worldwide use of lead-free solder pastes is increasing.

Several methods exist for reflowing; for example, convection or convection/infrared heating in a conveyor type oven. Throughput times (preheating, soldering and cooling) vary between 100 and 200 seconds depending on heating method.

Typical reflow peak temperatures range from 215 to $270^{\circ} \mathrm{C}$ depending on solder paste material. The top-surface temperature of the packages should preferably be kept:

- below $220^{\circ} \mathrm{C}$ (SnPb process) or below $245{ }^{\circ} \mathrm{C}(\mathrm{Pb}$-free process)
- for all the BGA packages
- for packages with a thickness $\geq 2.5 \mathrm{~mm}$
- for packages with a thickness < 2.5 mm and a volume $\geq 350 \mathrm{~mm}^{3}$ so called thick/large packages.
- below $235^{\circ} \mathrm{C}$ (SnPb process) or below $260^{\circ} \mathrm{C}$ (Pb-free process) for packages with a thickness $<2.5 \mathrm{~mm}$ and a volume < $350 \mathrm{~mm}^{3}$ so called small/thin packages.

Moisture sensitivity precautions, as indicated on packing, must be respected at all times.

## Wave soldering

Conventional single wave soldering is not recommended for surface mount devices (SMDs) or printed-circuit boards with a high component density, as solder bridging and non-wetting can present major problems.

To overcome these problems the double-wave soldering method was specifically developed.

If wave soldering is used the following conditions must be observed for optimal results:

- Use a double-wave soldering method comprising a turbulent wave with high upward pressure followed by a smooth laminar wave.
- For packages with leads on two sides and a pitch (e):
- larger than or equal to 1.27 mm , the footprint longitudinal axis is preferred to be parallel to the transport direction of the printed-circuit board;
- smaller than 1.27 mm , the footprint longitudinal axis must be parallel to the transport direction of the printed-circuit board.

The footprint must incorporate solder thieves at the downstream end.

- For packages with leads on four sides, the footprint must be placed at a $45^{\circ}$ angle to the transport direction of the printed-circuit board. The footprint must incorporate solder thieves downstream and at the side corners.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Typical dwell time of the leads in the wave ranges from 3 to 4 seconds at $250^{\circ} \mathrm{C}$ or $265^{\circ} \mathrm{C}$, depending on solder material applied, SnPb or Pb -free respectively.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

## Manual soldering

Fix the component by first soldering two diagonally-opposite end leads. Use a low voltage ( 24 V or less) soldering iron applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to $300^{\circ} \mathrm{C}$.

When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and $320^{\circ} \mathrm{C}$.

## Dual 4-channel analog multiplexer, demultiplexer

Suitability of surface mount IC packages for wave and reflow soldering methods

| PACKAGE ${ }^{(1)}$ | SOLDERING METHOD |  |
| :---: | :---: | :---: |
|  | WAVE | REFLOW ${ }^{(2)}$ |
| BGA, LBGA, LFBGA, SQFP, TFBGA, VFBGA | not suitable | suitable |
| DHVQFN, HBCC, HBGA, HLQFP, HSQFP, HSOP, HTQFP, HTSSOP, HVQFN, HVSON, SMS | not suitable ${ }^{(3)}$ | suitable |
| PLCC ${ }^{(4)}$, SO, SOJ | suitable | suitable |
| LQFP, QFP, TQFP | not recommended ${ }^{(4)(5)}$ | suitable |
| SSOP, TSSOP, VSO, VSSOP | not recommended ${ }^{(6)}$ | suitable |

## Notes

1. For more detailed information on the BGA packages refer to the "(LF)BGA Application Note" (AN01026); order a copy from your Philips Semiconductors sales office.
2. All surface mount (SMD) packages are moisture sensitive. Depending upon the moisture content, the maximum temperature (with respect to time) and body size of the package, there is a risk that internal or external package cracks may occur due to vaporization of the moisture in them (the so called popcorn effect). For details, refer to the Drypack information in the "Data Handbook IC26; Integrated Circuit Packages; Section: Packing Methods".
3. These packages are not suitable for wave soldering. On versions with the heatsink on the bottom side, the solder cannot penetrate between the printed-circuit board and the heatsink. On versions with the heatsink on the top side, the solder might be deposited on the heatsink surface.
4. If wave soldering is considered, then the package must be placed at a $45^{\circ}$ angle to the solder wave direction. The package footprint must incorporate solder thieves downstream and at the side corners.
5. Wave soldering is suitable for LQFP, TQFP and QFP packages with a pitch (e) larger than 0.8 mm ; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.65 mm .
6. Wave soldering is suitable for SSOP, TSSOP, VSO and VSSOP packages with a pitch (e) equal to or larger than 0.65 mm ; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.5 mm .

# Dual 4-channel analog multiplexer, demultiplexer 

## DATA SHEET STATUS

| LEVEL | DATA SHEET STATUS ${ }^{(1)}$ | PRODUCT STATUS ${ }^{(2)(3)}$ | DEFINITION |
| :---: | :---: | :---: | :---: |
| I | Objective data | Development | This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice. |
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## Notes

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2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

## DEFINITIONS

Short-form specification - The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition - Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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Dual 4-channel analog multiplexer, demultiplexer

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Dual 4-channel analog multiplexer, demultiplexer

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## Contact information

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